

M61524FP

2ch ELECTRONIC VOLUME WITH 4 INPUT SELECTOR

REJ03F0035-0100Z

Rev.1.0

Sep.19.2003

Features

Function	FEATURES
Input selector	4input selector MUTE
Input gain control	0,+3,+6,+9dB
Karaoke mode	Stereo, Lch mono, Rch mono, Vocal cut
MIC MIX	Mixing before the output of REC MIC amp:+6dB, With the MIC SWs
REC Output	LRch each one output
Surround	With the ON/OFF SWs
Main Volume	0 -90dB, -∞/1dB step • A volume 0 to -24dB/1dB step • B volume 0 to -66dB, -∞/1dB step Each channel is independence control.
Tone control	(1) Bass -8 +14dB/2dB step,f0=100Hz (2) Mid:±8dB/2dB step,f0=1KHz (3) Treble: ±8dB/2dB step,f0=10KHz Add a Bypass Mode/Tone Mode changing SWs
Bass boost	High Pass Filter Type
Microcomputer Interface	2 line serial data control .

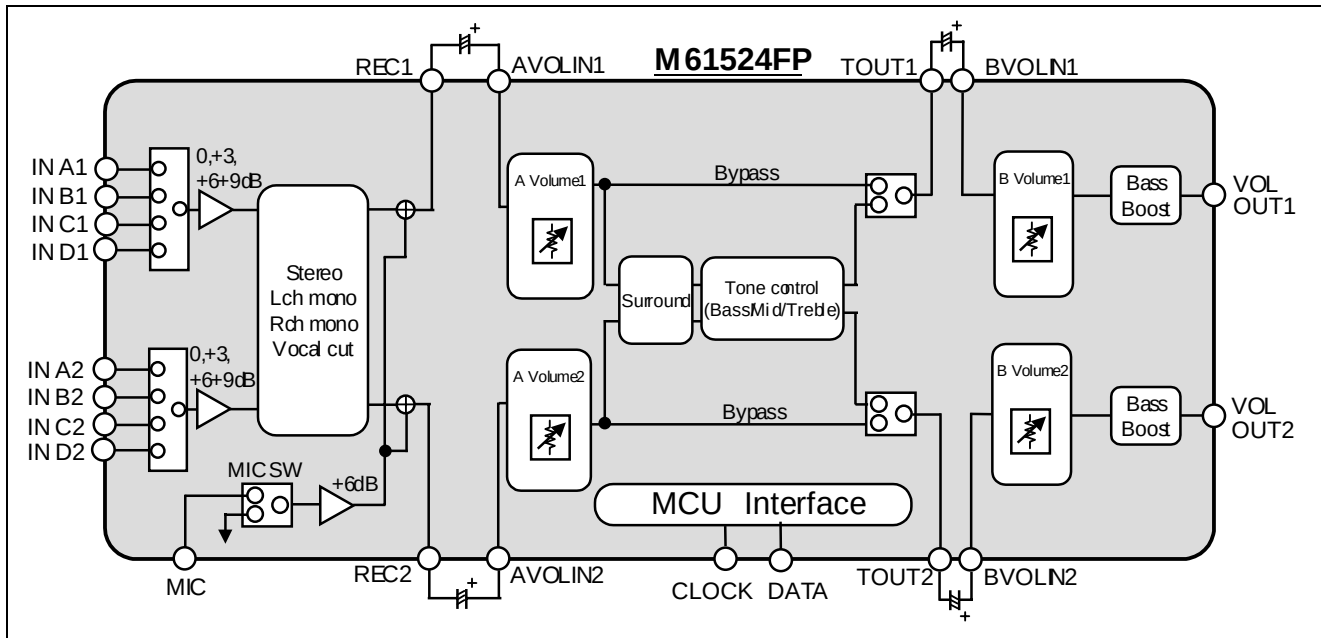
Application

Mini Stereo, etc.

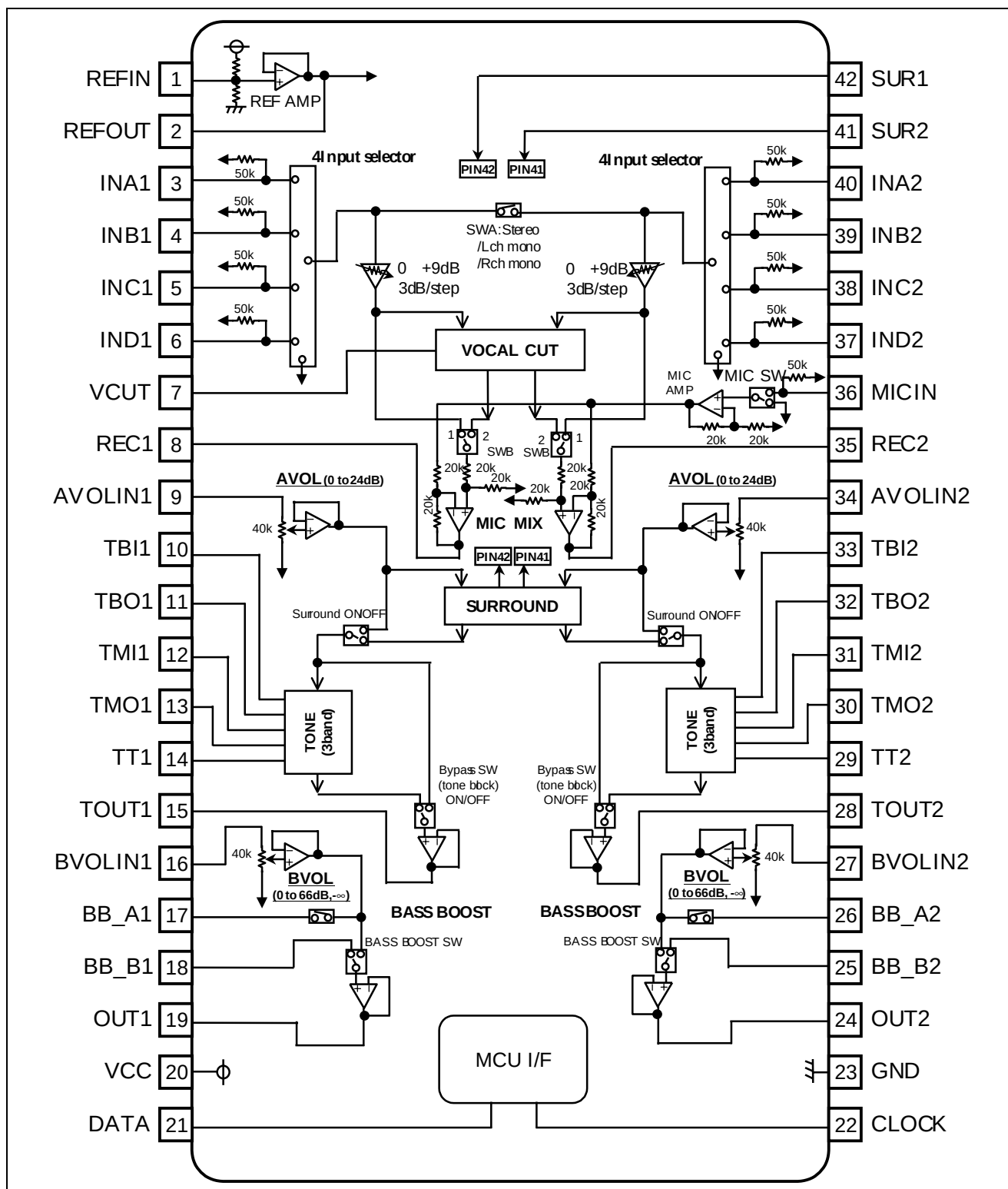
Recommended Operating Condition

Rated Supply voltageVCC = 9.0V (typ)

System Configuration



Block Diagram and Pin Configuration (Top View)



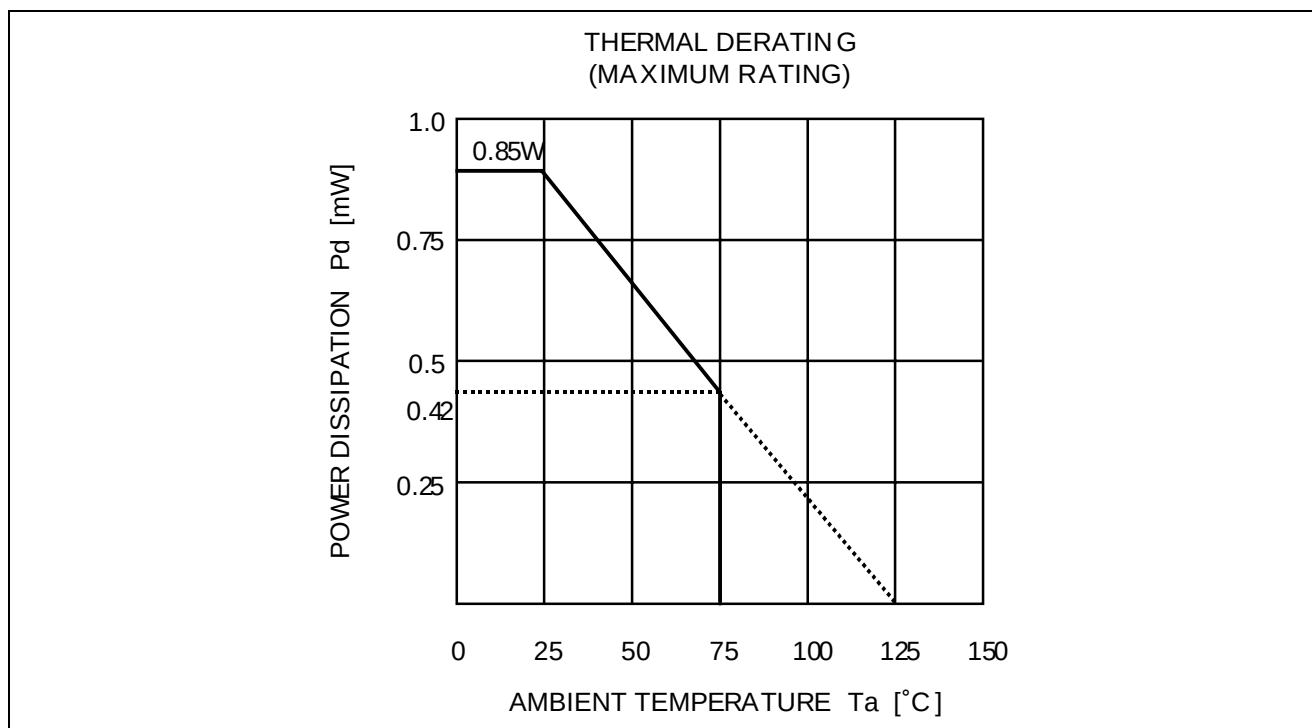
Pin Description

Pin No.	Terminal name	Function
1	REFIN	Input pin of reference Amp
2	REFOUT	Output pin of reference Amp
3,4,5,6, 37,38,39,40	INA~IND	Input pin of input selector (Ch1 and Ch2)
7	VCUT	Frequency characteristic setting pin of vocal cut
8,35	REC	Output pin of REC (Ch1 and Ch2)
9,34	AVOLIN	Input pin of A volume (Ch1 and Ch2)
10,11,12,13,14, 29,30,31,32,33	TBI,TBO,TMI,TMO,TT	Frequency characteristic setting pin of tone control (Bass/Mid/Treble)
15,28	TOUT	Output pin of tone (Ch1 and Ch2)
16,27	BVOLIN	Input pin of B volume (Ch1 and Ch2)
17,18,25,26	BB_A,BB_B	Frequency characteristic setting pin of bass boost
19,24	OUT	Output pin (Ch1 and Ch2)
20	VCC	The power supply
21	DATA	Input pin of Control Trigger (DATA)
22	CLOCK	Input pin of Control Trigger (CLOCK)
23	GND	GND
36	MICIN	Input pin of MIC AMP
41,42	SUR	Frequency characteristic setting pin of Surround

Absolute Maximum Ratings

(Ta=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Units
Power supply	VCC		10.5	V
Pd	Power dissipation	Ta ≤ 25°C	850	mW
K	Thermal derating	Ta > 25°C	8.6	mW/°C
Topr	Operating temperature		-20 to +75	°C
Tstg	Storage temperature		-40 to +125	°C

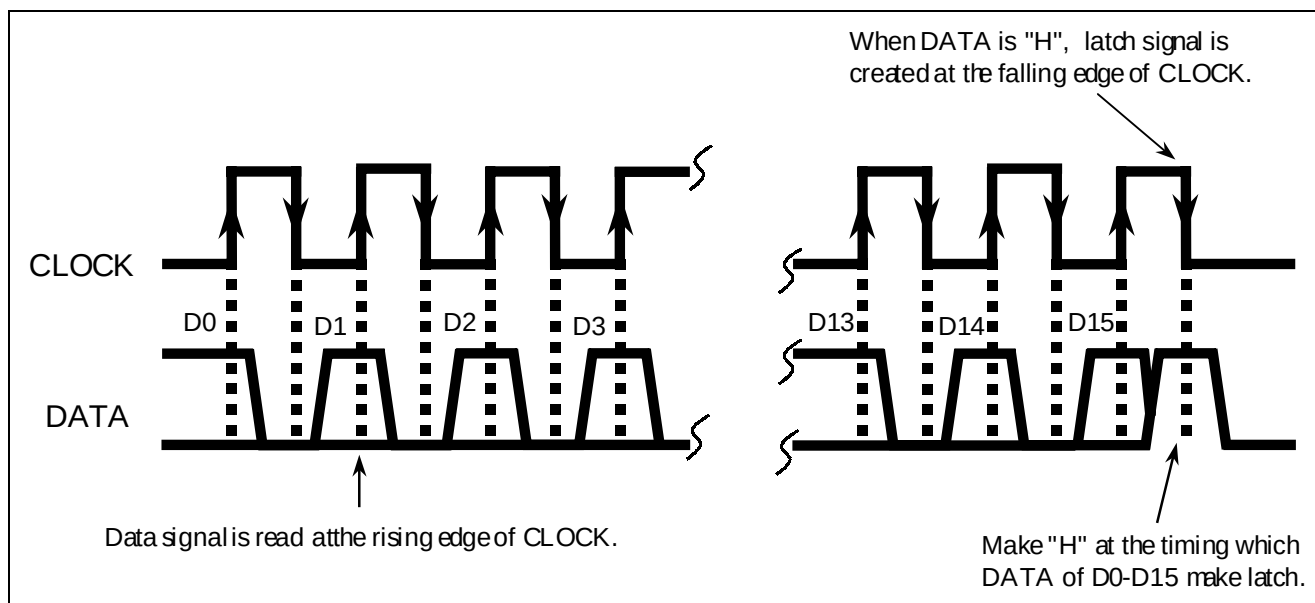


Recommended Operating Condition

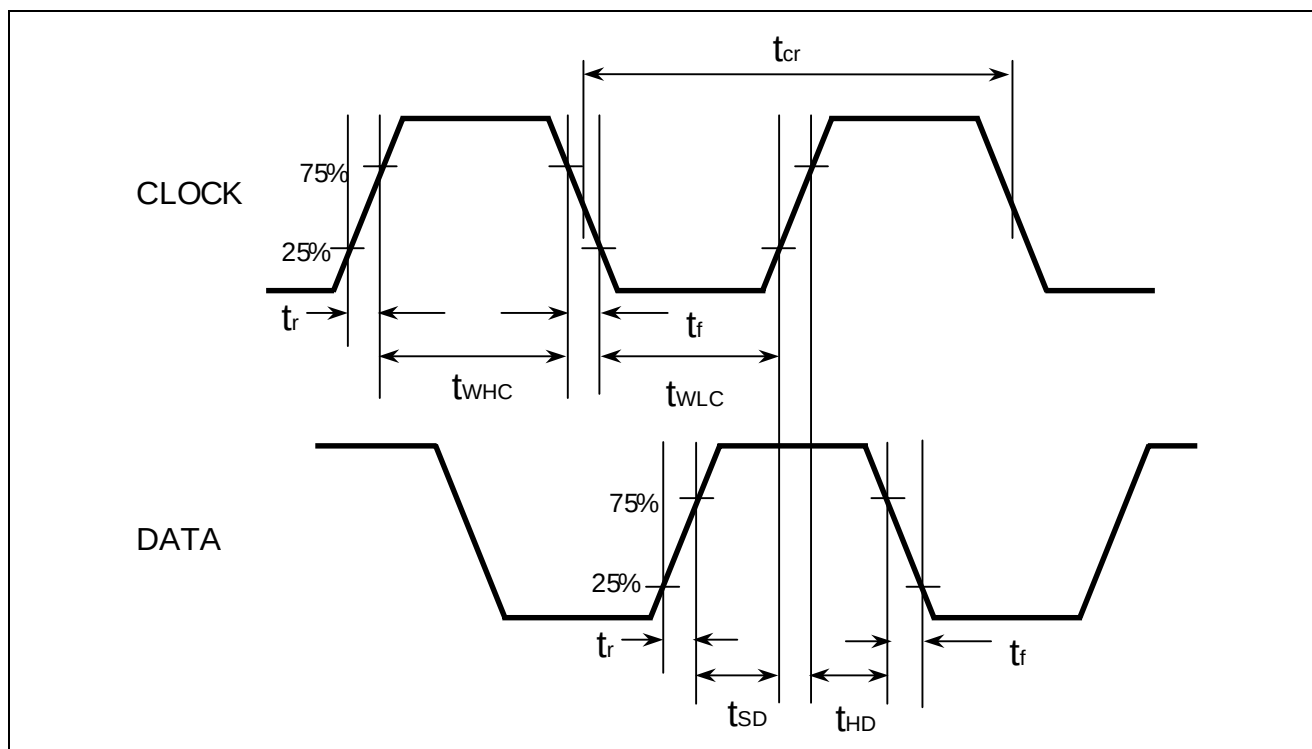
(Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Limits			Units
			MIN	TYP	MAX	
Supply voltage	VCC		8	9	10	V
Logic "H" level input voltage	VIH	VCC=9V GND reference	2.2	—	5.5	V
Logic "L" level input voltage	VIL	VCC=9V GND reference	0	—	0.6	V

Relationship between Data and Clock



Clock and Data Timings



Timing Definition of Digital Block

Symbol	Parameter	Limits			Units
		MIN	TYP	MAX	
t_{cr}	CLOCK cycle time	4	—	—	μS
t_{WHC}	CLOCK pulse width ("H" level)	1.6	—	—	
t_{WLC}	CLOCK pulse width ("L" level)	1.6	—	—	
t_r	Rising time of clock and data	—	—	0.4	
t_f	Falling time of clock and data	—	—	0.4	
t_{SD}	DATA setup time	0.8	—	—	
t_{HD}	DATA hold time	0.8	—	—	

Data Control Specification

Four types of input format can be selected by changing the D14/D15 slot setting status.

(Initialize all data of the 4 formats when power supply(VCC) turn on.)

(1)

D0a	D1a	D2a	D3a	D4a	D5a	D6a	D7a	D8a	D9a	D10a	D11a	D12a	D13a	D14a	D15a
1. Input selector			2. Karaoke mode control		3. Input gain control		4. Surro und	5. MIC SW	0	0	0	0	0	0	0

(2)

D0b	D1b	D2b	D3b	D4b	D5b	D6b	D7b	D8b	D9b	D10b	D11b	D12b	D13b	D14b	D15b
6. Tone control Bass				6. Tone control Mid				6. Tone control Treble				7. Bypass SW (tone block)	8. Bass boost	0	1

(3)

D0c	D1c	D2c	D3c	D4c	D5c	D6c	D7c	D8c	D9c	D10c	D11c	D12c	D13c	D14c	D15c
9. Lch A volume					10. Lch B Volume							0	0	1	0

(4)

D0d	D1d	D2d	D3d	D4d	D5d	D6d	D7d	D8d	D9d	D10d	D11d	D12d	D13d	D14d	D15d
9. Rch A volume					10. Rch B volume							0	0	1	1

Setting Code

 It's initial setting when VCC turn on.

1. Input selector

	D0a	D1a	D2a
INA	0	0	0
INB	0	0	1
INC	0	1	0
IND	0	1	1
ALL OFF	1	1	1

2. Karaoke mode control

	D3a	D4a
Stereo	0	0
Lch mono	0	1
Rch mono	1	0
Vocal cut	1	1

3. Input gain control

	D5a	D6a
0dB	0	0
+3dB	0	1
+6dB	1	0
+9dB	1	1

4. Surround ON/OFF

	D7a
OFF	0
ON	1

5. MIC SW

	D8a
OFF	0
ON	1

6. Tone control (Bass/Mid/Treble)

ATT	Bass	D0b	D1b	D2b	D3b
	Mid	D4b	D5b	D6b	D7b
	Treble	D8b	D9b	D10b	D11b
+14dB*	1	1	1	1	1
+12dB*	1	1	1	0	0
+10dB*	1	1	0	1	1
+ 8dB	1	1	0	0	0
+ 6dB	1	0	1	1	1
+ 4dB	1	0	1	0	0
+ 2dB	1	0	0	1	1
0dB	0	0	0	0	0
- 2dB	0	0	0	1	1
- 4dB	0	0	1	0	0
- 6dB	0	0	1	1	1
- 8dB	0	1	0	0	0

*: +14dB +10dB can set up only a Bass.

7. BypassSW
(tone block)

	D12b
ON	0
OFF	1

8. Bass boost

	D13b
OFF	0
ON	1

9. A volume

ATT	Lch AVOL	D0c	D1c	D2c	D3c	D4c
	Rch AVOL	D0d	D1d	D2d	D3d	D4d
0dB	0	0	0	0	0	0
-1dB	0	0	0	0	0	1
-2dB	0	0	0	0	1	0
-3dB	0	0	0	0	1	1
-4dB	0	0	1	0	0	0
-5dB	0	0	1	0	1	1
-6dB	0	0	1	1	0	0
-7dB	0	0	1	1	1	1
-8dB	0	1	0	0	0	0
-9dB	0	1	0	0	1	1
-10dB	0	1	0	1	0	0
-11dB	0	1	0	1	1	1
-12dB	0	1	1	0	0	0
-13dB	0	1	1	0	1	1
-14dB	0	1	1	1	0	0
-15dB	0	1	1	1	1	1
-16dB	1	0	0	0	0	0
-17dB	1	0	0	0	1	1
-18dB	1	0	0	1	0	0
-19dB	1	0	0	1	1	1
-20dB	1	0	1	0	0	0
-21dB	1	0	1	0	1	1
-22dB	1	0	1	1	1	0
-23dB	1	0	1	1	1	1
-24dB	1	1	0	0	0	0

Note : Please don't input except specification data.

10. B volume

ATT	Lch BVOL	D5c	D6c	D7c	D8c	D9c	D10c	D11c
	Rch BVOL	D5d	D6d	D7d	D8d	D9d	D10d	D11d
0dB		0	0	0	0	0	0	0
-1dB		0	0	0	0	0	0	1
-2dB		0	0	0	0	0	1	0
-3dB		0	0	0	0	0	1	1
-4dB		0	0	0	0	1	0	0
-5dB		0	0	0	0	1	0	1
-6dB		0	0	0	0	1	1	0
-7dB		0	0	0	0	1	1	1
-8dB		0	0	0	1	0	0	0
-9dB		0	0	0	1	0	0	1
-10dB		0	0	0	1	0	1	0
-11dB		0	0	0	1	0	1	1
-12dB		0	0	0	1	1	0	0
-13dB		0	0	0	1	1	0	1
-14dB		0	0	0	1	1	1	0
-15dB		0	0	0	1	1	1	1
-16dB		0	0	1	0	0	0	0
-17dB		0	0	1	0	0	0	1
-18dB		0	0	1	0	0	1	0
-19dB		0	0	1	0	0	1	1
-20dB		0	0	1	0	1	0	0
-21dB		0	0	1	0	1	0	1
-22dB		0	0	1	0	1	1	0
-23dB		0	0	1	0	1	1	1
-24dB		0	0	1	1	0	0	0
-25dB		0	0	1	1	0	0	1
-26dB		0	0	1	1	0	1	0
-27dB		0	0	1	1	0	1	1
-28dB		0	0	1	1	1	0	0
-29dB		0	0	1	1	1	0	1
-30dB		0	0	1	1	1	1	0
-31dB		0	0	1	1	1	1	1
-32dB		0	1	0	0	0	0	0
-33dB		0	1	0	0	0	0	1
-34dB		0	1	0	0	0	1	0
-35dB		0	1	0	0	0	1	1
-36dB		0	1	0	0	1	0	0
-37dB		0	1	0	0	1	0	1
-38dB		0	1	0	0	1	1	0
-39dB		0	1	0	0	1	1	1
-40dB		0	1	0	1	0	0	0
-41dB		0	1	0	1	0	0	1
-42dB		0	1	0	1	0	1	0
-43dB		0	1	0	1	0	1	1
-44dB		0	1	0	1	1	0	0

ATT	LchVOL	D5c	D6c	D7c	D8c	D9c	D10c	D11c
	RchVOL	D5d	D6d	D7d	D8d	D9d	D10d	D11d
-45dB		0	1	0	1	1	0	1
-46dB		0	1	0	1	1	1	0
-47dB		0	1	0	1	1	1	1
-48dB		0	1	1	0	0	0	0
-49dB		0	1	1	0	0	0	1
-50dB		0	1	1	0	0	1	0
-51dB		0	1	1	0	0	1	1
-52dB		0	1	1	0	1	0	0
-53dB		0	1	1	0	1	0	1
-54dB		0	1	1	0	1	1	0
-55dB		0	1	1	0	1	1	1
-56dB		0	1	1	1	0	0	0
-57dB		0	1	1	1	0	0	1
-58dB		0	1	1	1	0	1	0
-59dB		0	1	1	1	0	1	1
-60dB		0	1	1	1	1	0	0
-61dB		0	1	1	1	1	0	1
-62dB		0	1	1	1	1	1	0
-63dB		0	1	1	1	1	1	1
-64dB		1	0	0	0	0	0	0
-65dB		1	0	0	0	0	0	1
-66dB		1	0	0	0	0	1	0
-∞ dB		1	1	0	0	0	0	0

Note : Please don't input except specification data.

Electrical Characteristics

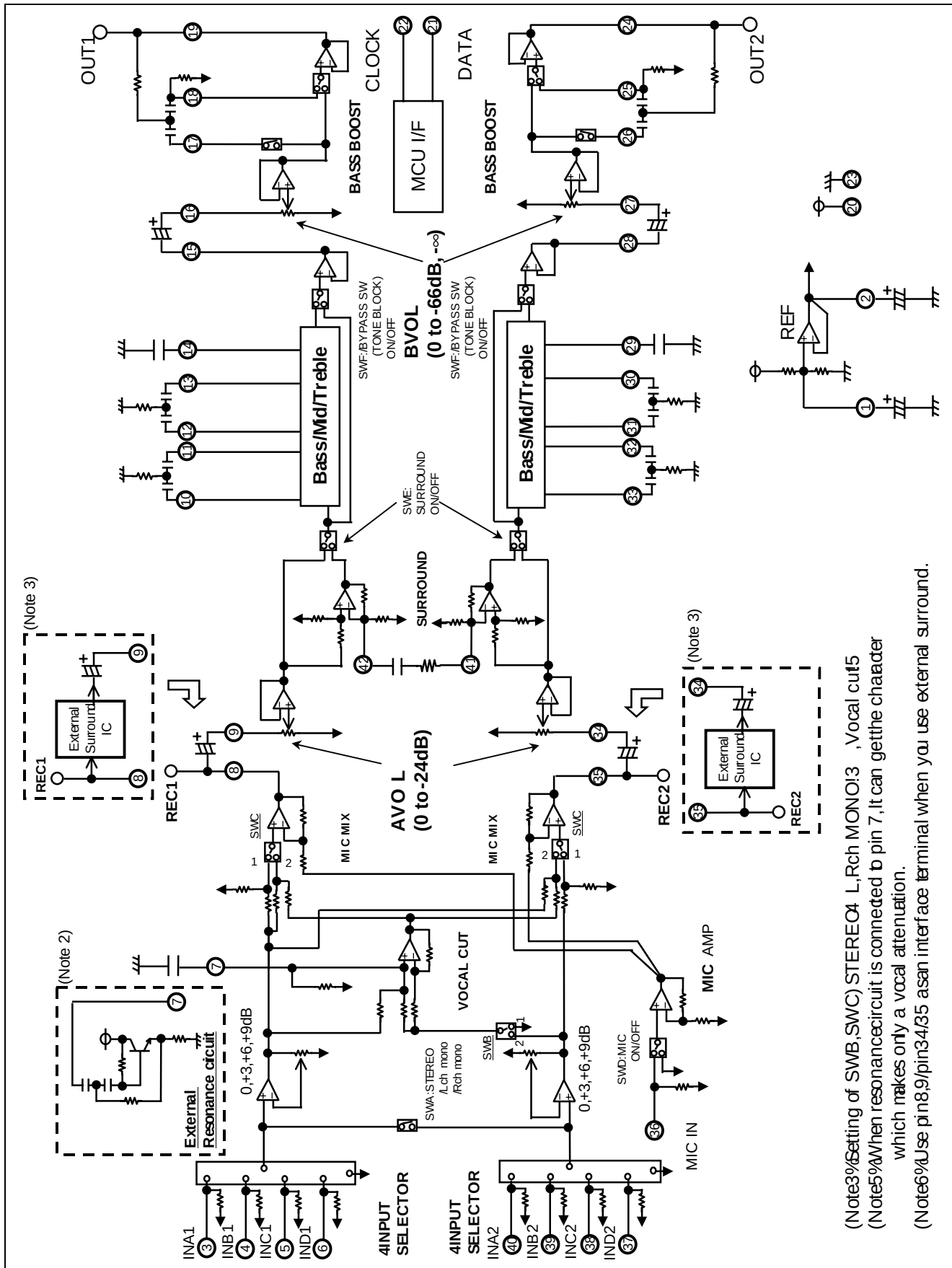
Unless otherwise noted, Ta=25°C, VCC=9V, f=1kHz,

Input gain control=0dB, Karaoke mode control=Stereo, MIC SW=OFF, Surround=OFF, Bypass SW (tone block)=ON,

Tone=Flat, Bass boost=OFF, A/B volume=0dB

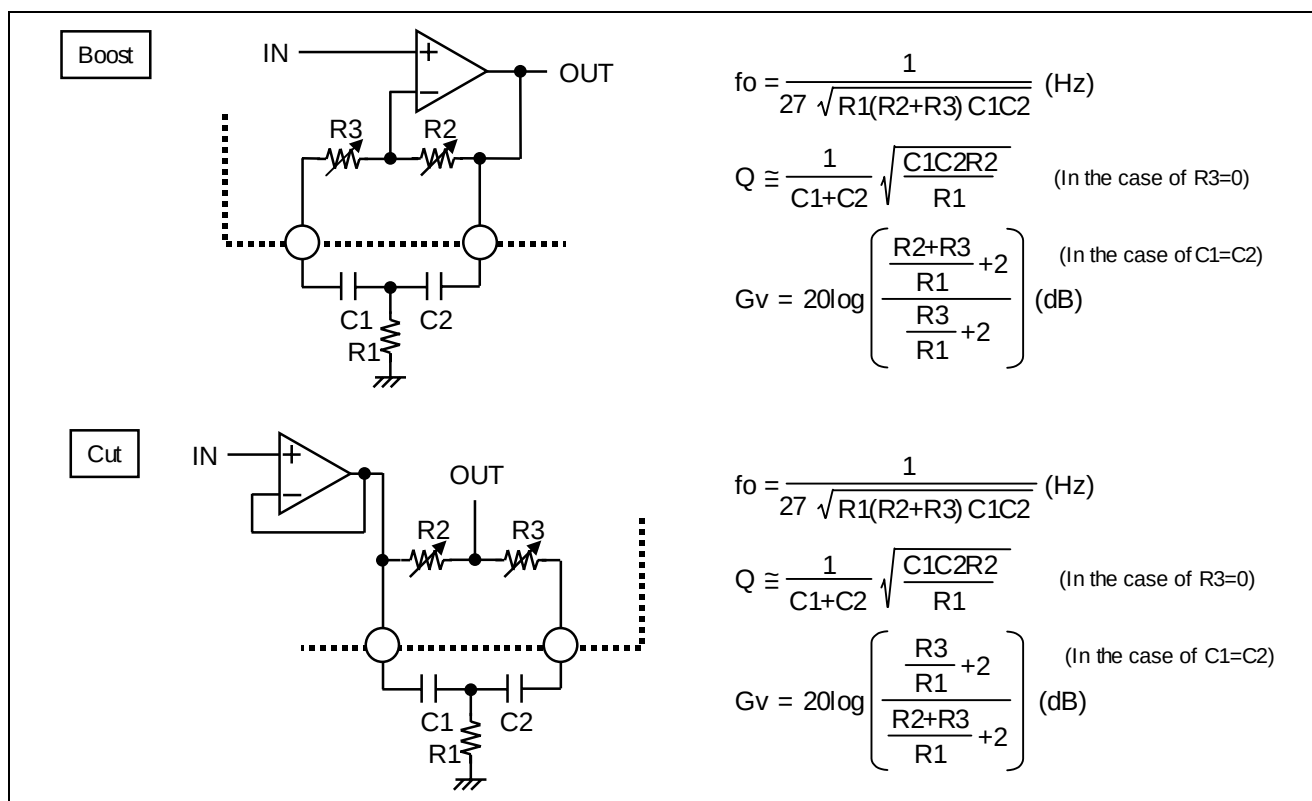
	Parameter	Symbol	Condition	Limits			Units
				MIN	TYP	MAX	
Input/Output characteristics (OVER ALL)	Circuit current	IACC	No signal, Pin20 current	—	20	40	mA
	Input resistance	Rin	3,4,5,6Pin/37,38,39,40Pin/36Pin	25k	50k	75k	Ω
	Maximum input voltage	VIM	(3,40)Pin input,(19,24)Pin output RL=10k, THD=1%	1.6	2.0	—	Vrms
	Maximum output voltage	VOM	(3,40)Pin input,(19,24)Pin output RL=10k, THD=5%,Bass boost ON, f=50Hz	1.8	2.2	—	Vrms
	Pass gain	Gv	(3-19)Pin-(40-24)Pin Vi=1Vrms,FLAT	-2.0	0.0	2.0	dB
	Maximum attenuation	ATT	Vo=1Vrms,(19,24)Pin output JIS-A, VOL=-∞	—	-90	-85	dB
	Output noise voltage	VnoA	No signal, JIS-A, Rg=0 , 19,24Pin output	—	4	8	μVrms
		VnoB					μVrms
		VnoC					μVrms
	Total harmonic distortion	THDA	(3,40)Pin input,(19,24)Pin output BW:400 30kHz,Vo=0.5Vrms,RL=10kΩ	—	0.02	0.1	%
Tone C control characteristics	Cross talk of mutual channels	CT	(3-24)Pin-(40-19)Pin Vi=0.5Vrms,JIS-A,RL=10k ,Rg=0Ω	—	-70	-55	dB
	Bass voltage gain	GBbass	(9,34)Pin input (15,28)Pin output	12	14	16	dB
		GCbass	Vi=0.2Vrms, f=100Hz	-10	-8	-6	dB
	Mid voltage gain	GBmid	(9,34)Pin input	6	8	10	dB
		GCmid	(15,28)Pin output Vi=0.2Vrms, f=1kHz	-10	-8	-6	dB
	Treble voltage gain	GBtre	(9,34)Pin input (15,28)Pin output	6	8	10	dB
		GCtre	Vi=0.2Vrms, f=10kHz	-10	-8	-6	dB
	Balance of mutual channels	BALT	Boost condition +8,-8dB (9,34)Pin input,(15,28)Pin output	-2	0	2	dB

Internal Block Diagram

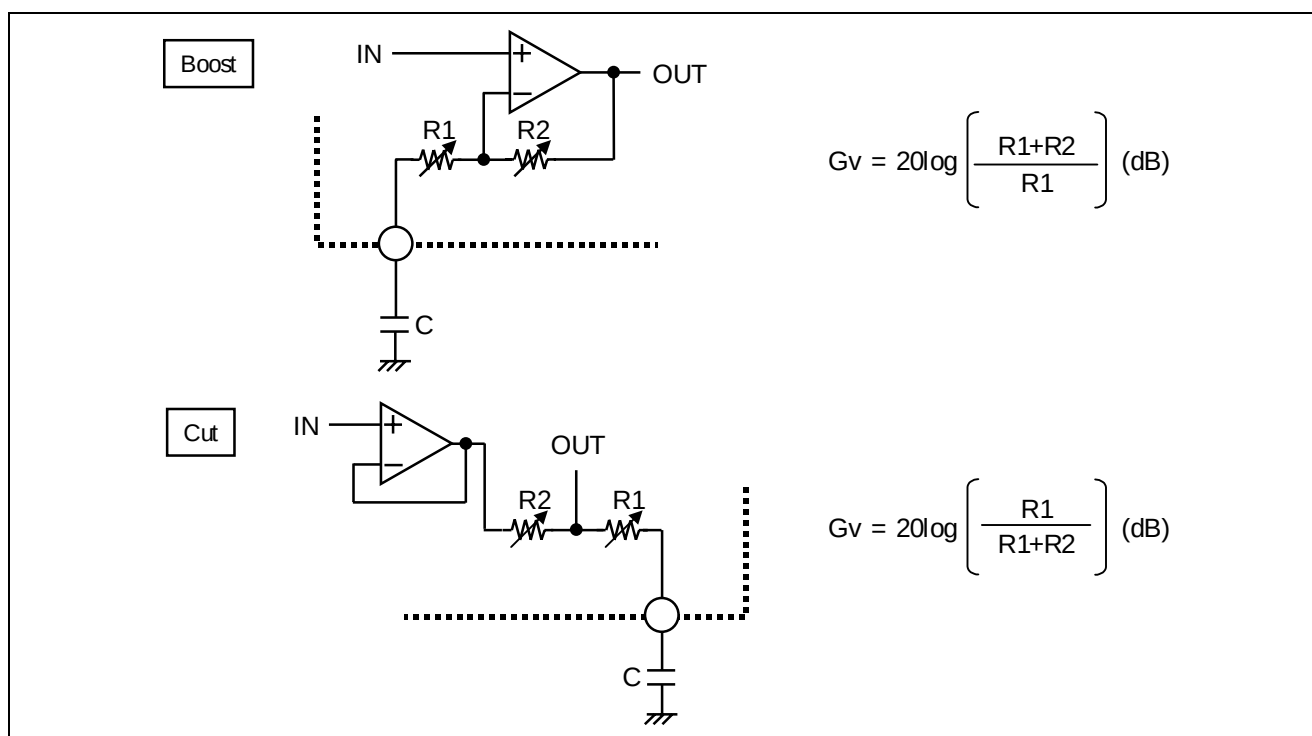


Tone Control

(1) Bass/Mid



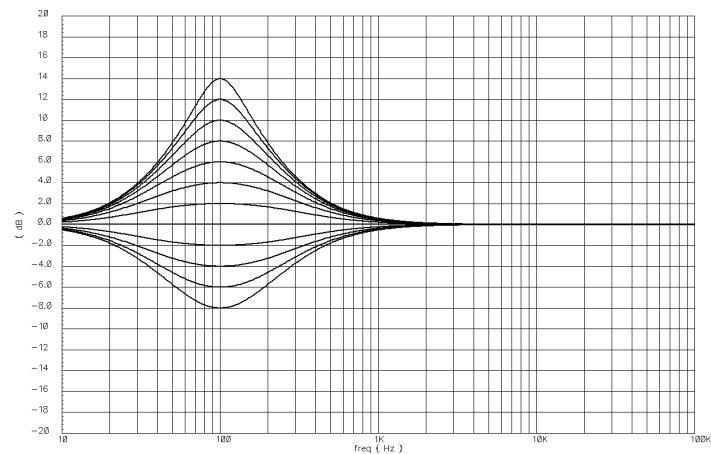
(2) Treble



Frequency response of tone control

* This frequency response is a simulation result.

(1) Bass (R1=2.2kΩ, C1=C2=0.22μF)

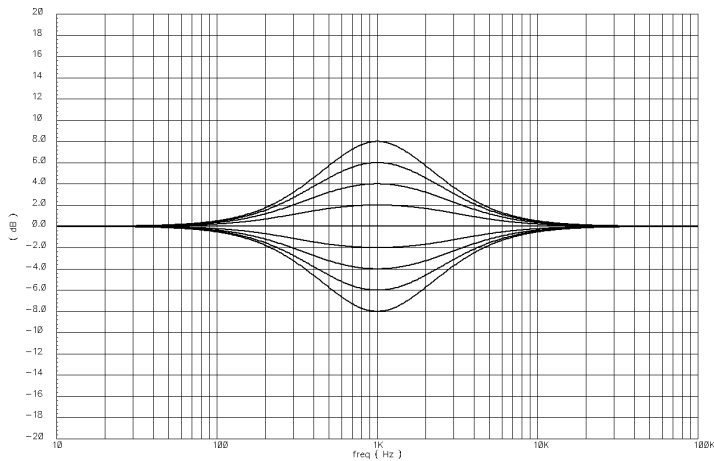


• Internal resistance value(Reference value)

	R2	R3
+14dB	22.6k	1.2k
+12dB	21.1k	2.7k
+10dB	19.3k	4.5k
± 8dB	17.0k	6.8k
± 6dB	14.1k	9.7k
± 4dB	10.4k	13.4k
± 2dB	5.8k	18.0k

(Units: Ω)

(2) Mid (R1=2.2kΩ, C1=C2=0.022μF)

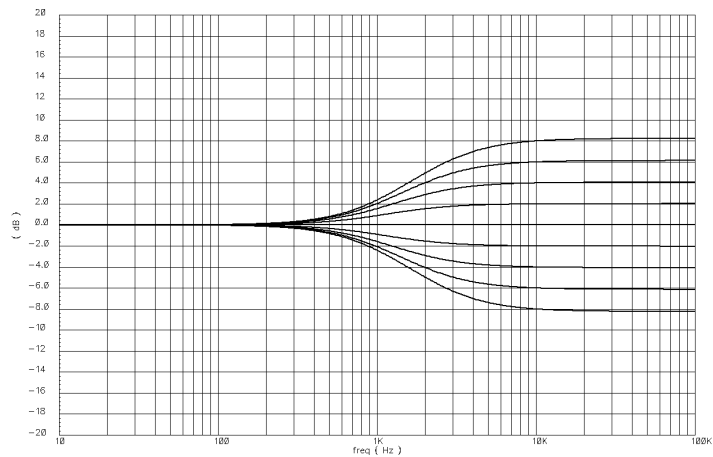


• Internal resistance value(Reference value)

	R2	R3
± 8dB	17.0k	6.8k
± 6dB	14.1k	9.7k
± 4dB	10.4k	13.4k
± 2dB	5.8k	18.0k

(Units: Ω)

(3) Treble (C=4700pF)

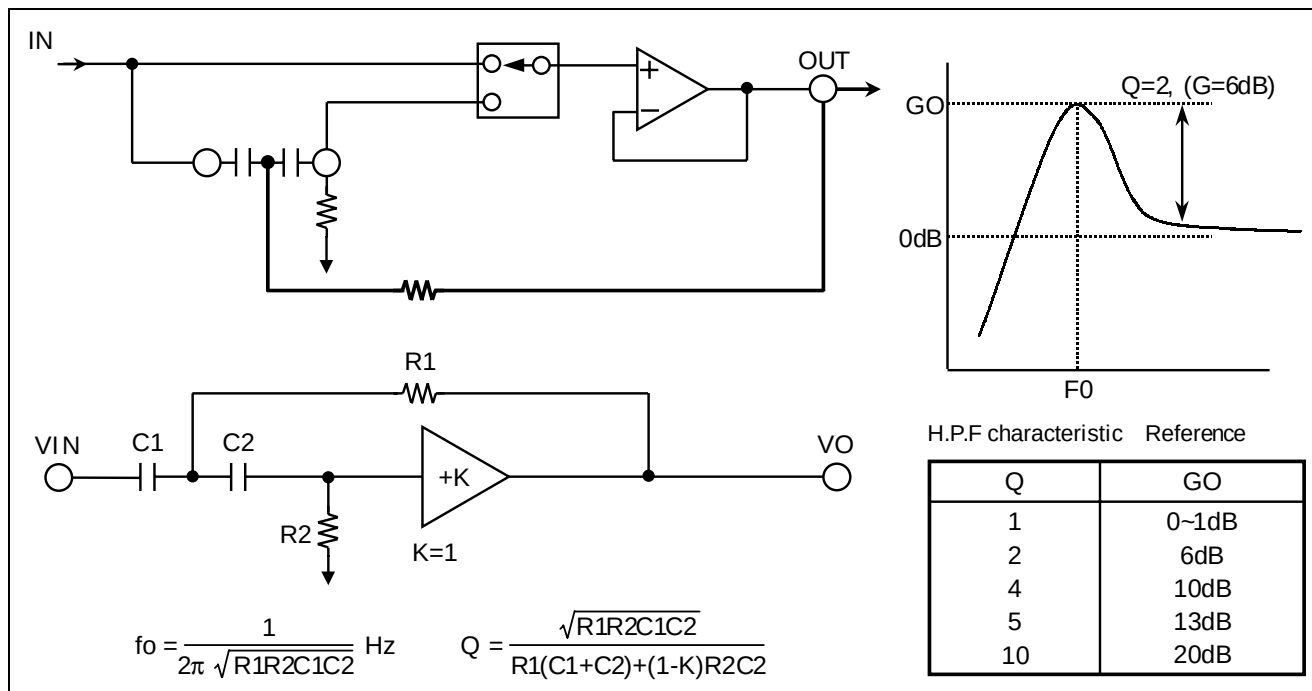


- Internal resistance value (Reference value)

	R1	R2
$\pm 8\text{dB}$	13.1k	20.8k
$\pm 6\text{dB}$	16.7k	17.2k
$\pm 4\text{dB}$	21.2k	12.7k
$\pm 2\text{dB}$	26.8k	7.1k

(Units: Ω)

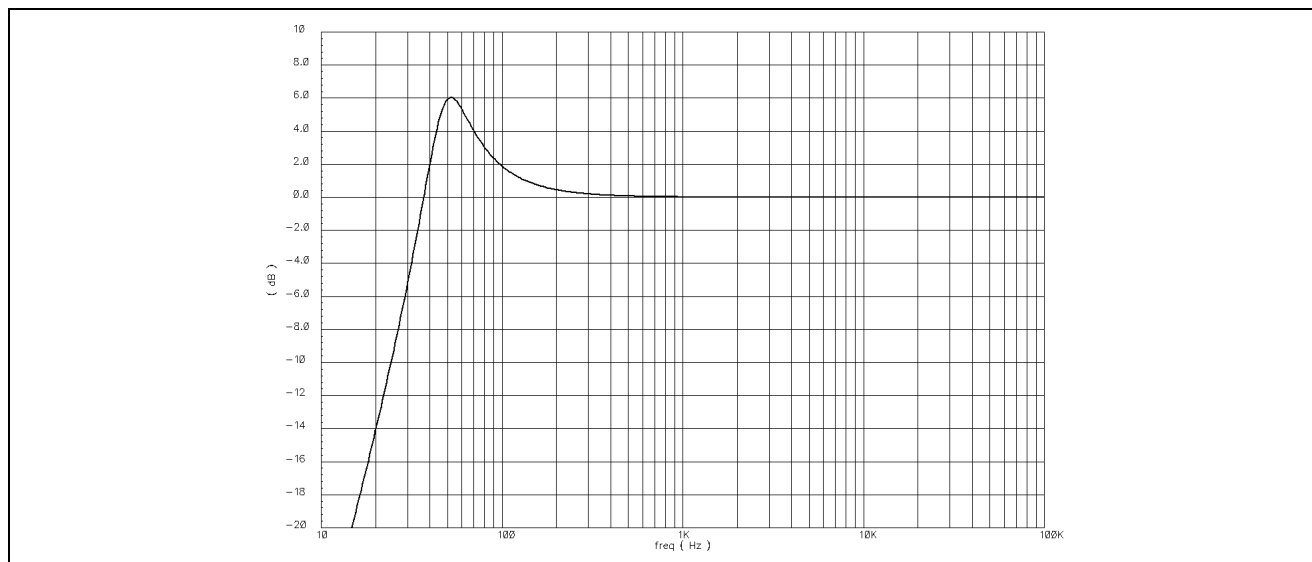
Bass Boost



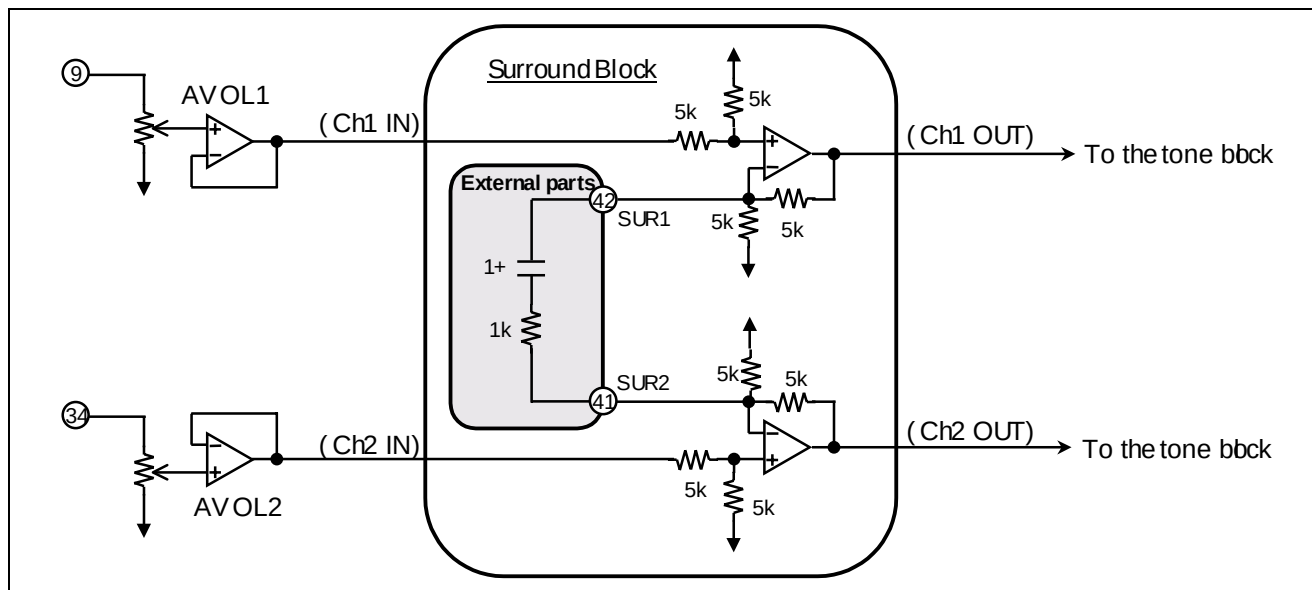
Frequency response of Bass boost

R1=1.8kΩ, R2=27kΩ, C1=C2=0.47μF (f0≒50Hz, Q≒2)

* This frequency response is a simulation result.

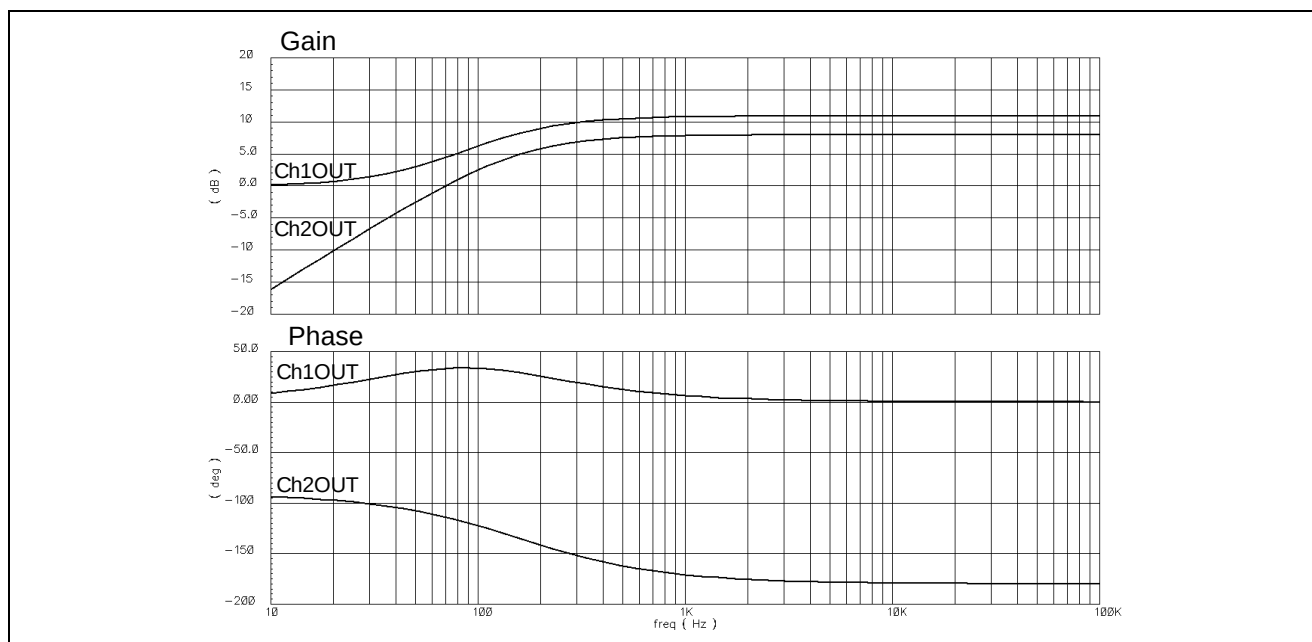


Surround



Frequency response of Surround (Ch1:input, Ch2:GND)

* This frequency response is a simulation result.



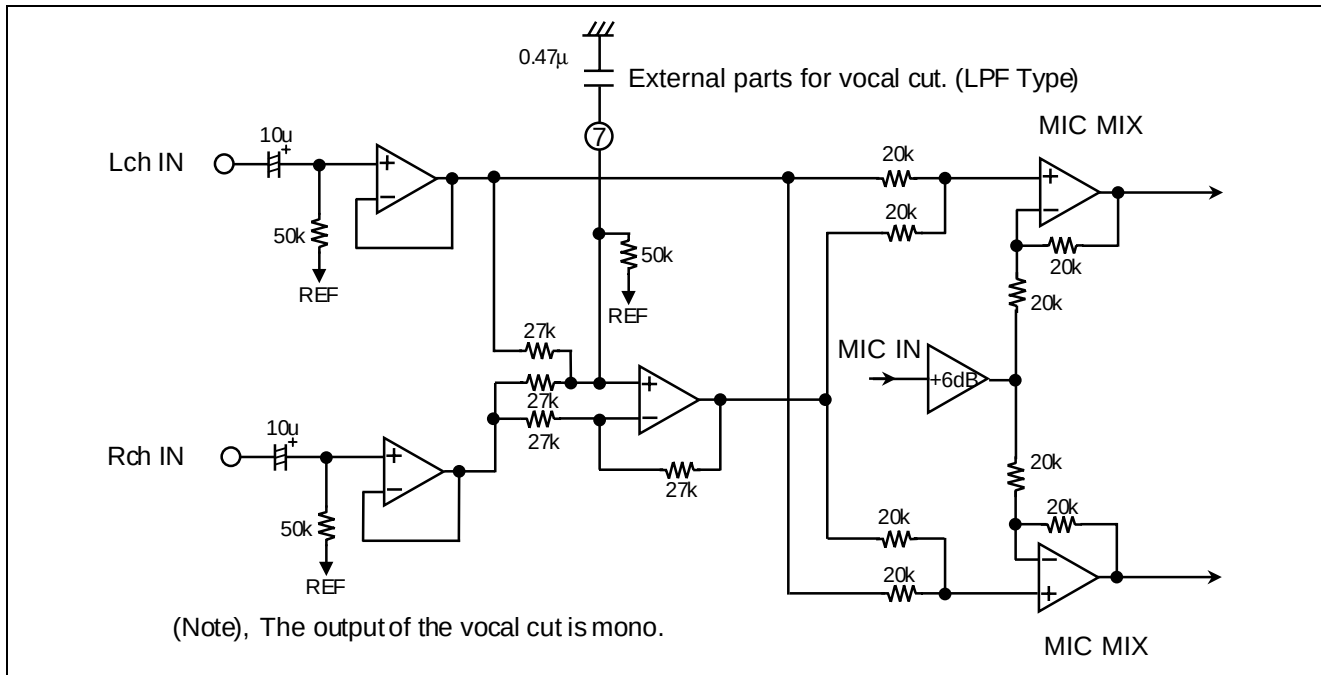
Vocal Cut

It is the function which attenuate a vocal from the music source.

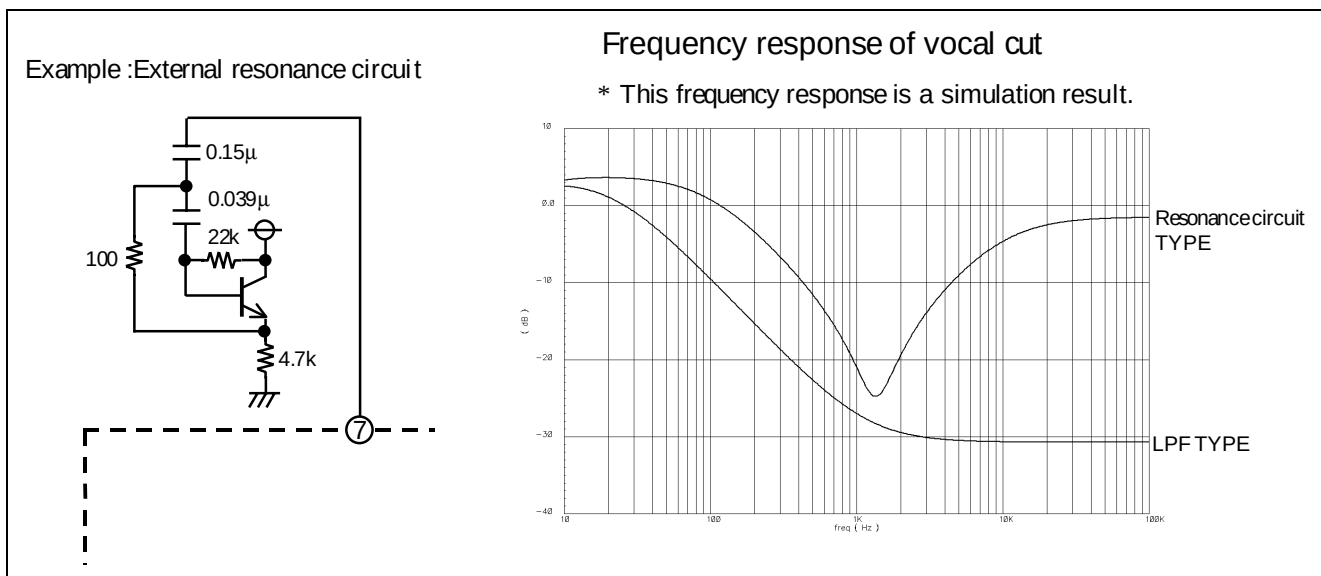
The vocal is usually located in the center. And it is same amplitude and phase in L and R channel.

So, a vocal inside music is attenuated by doing L-R. But, a low frequency signal be attenuated in this case.

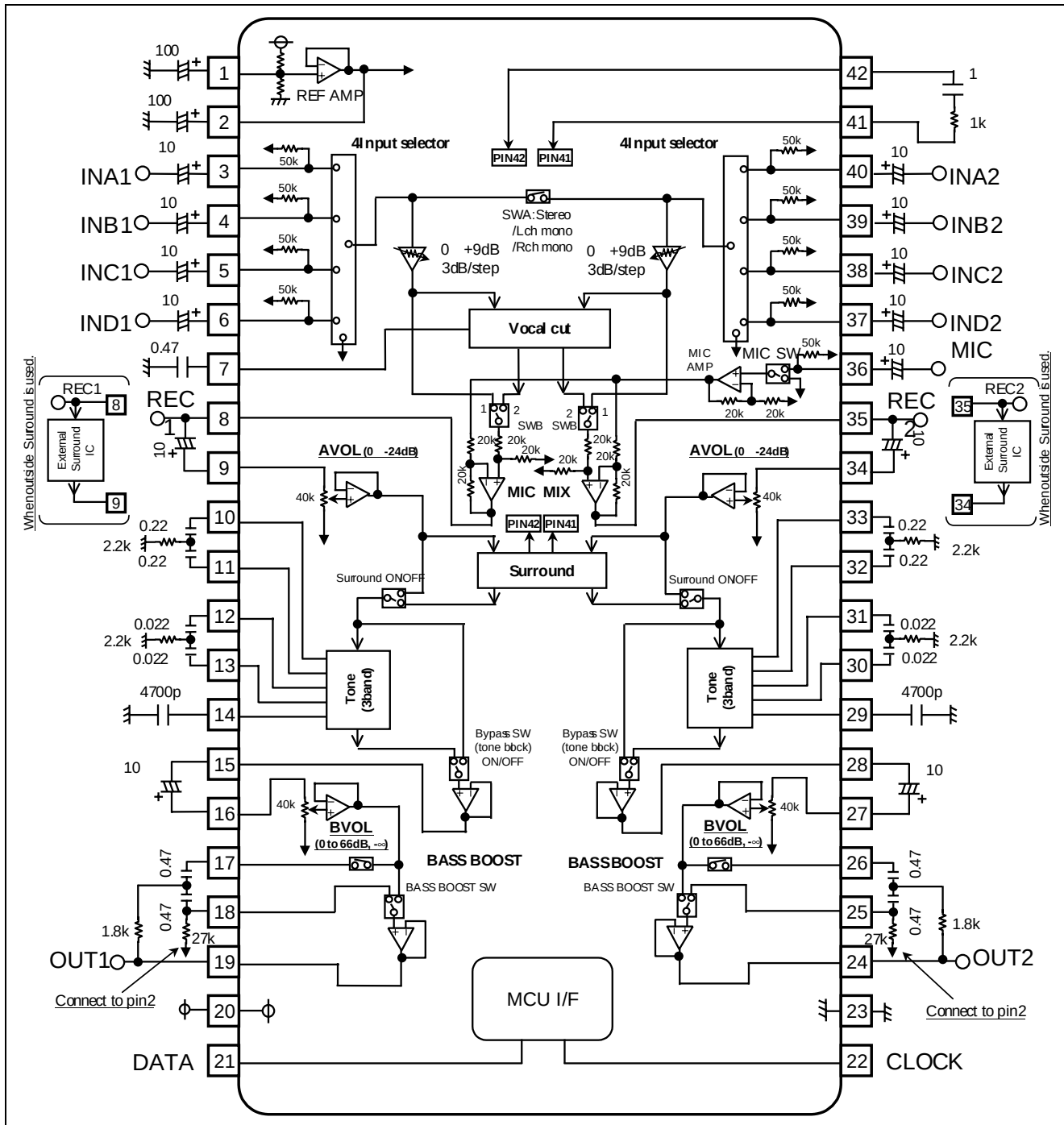
Therefore, a low frequency signal be made to pass with LPF, and it makes up for the shortage of the low frequency signal.



When resonance circuit is connected to pin 7, It can get the character which makes only a vocal attenuation.



Application Example



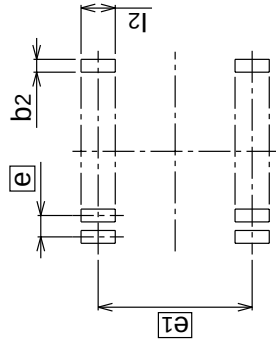
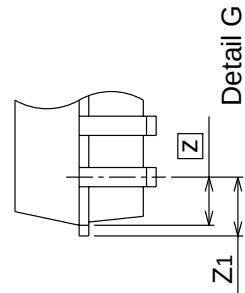
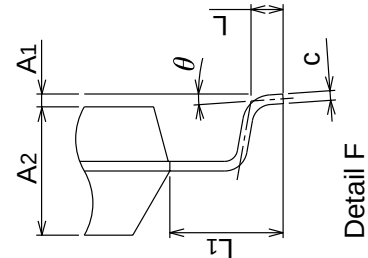
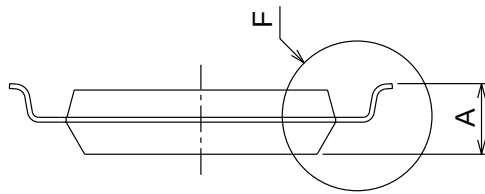
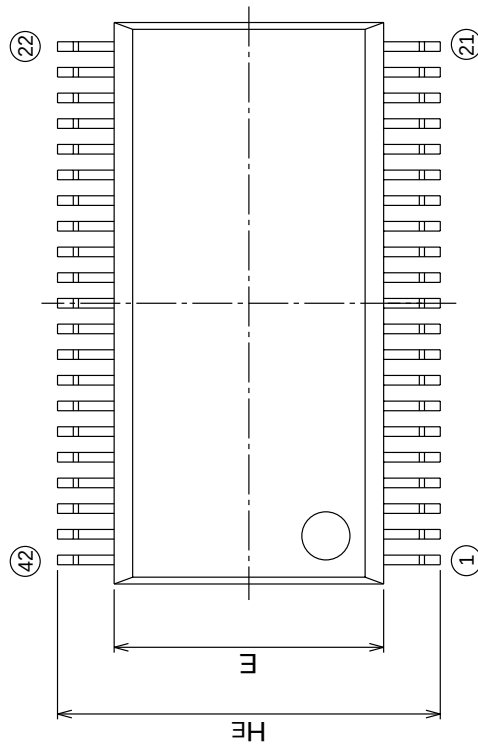
Package Dimensions

42P2R-E

(MMP)

Plastic 42pin 450mil SSOP

EIAJ Package Code	JEDEC Code	Weight(g)	Lead Material
SSOP42-P-450-0.80	—	—	Cu Alloy+42 Alloy



Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	—	—	2.4
A1	0.05	—	—
A2	—	2.0	—
b	0.25	0.3	0.4
c	0.13	0.15	0.2
D	17.3	17.5	17.7
E	8.2	8.4	8.6
e	—	0.8	—
HE	11.63	11.93	12.23
L	0.3	0.5	0.7
L1	—	1.765	—
Z	—	0.75	—
Z1	—	—	0.9
y	—	—	0.15
θ	0°	—	10°
b2	—	0.5	—
e1	—	11.43	—
l2	1.27	—	—

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